



PATENT

**In the United States Patent and Trademark Office**

Applicant: Adrian KIERMASZ	)	
Applicant's Reference: LAM2P452	)	Examiner: M. Rachuba
Application No. 10/743,923	)	Group Art Unit: 3723
Filed: December 22, 2003	)	Date: June 13, 2006
Title: LINEAR CHEMICAL MECHANICAL	)	Conf. No. 9016 (Notice of
PLANARIZATION (CMP) SYSTEM AND	)	Allowance mailed 03/13/06)
METHOD FOR PLANARIZING A WAFER	)	
IN A SINGLE CMP MODULE	)	

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June 13, 2006.

Signed: \_\_\_\_\_

Diane Schwanbeck

**Separate Letter to the Official Draftsperson**

Commissioner for Patents  
Post Office Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Applicant hereby attaches four (4) sheets of formal replacement drawings (Figures 1, 2A, 2B, and 3A-3C) for the above-identified patent application. In the event the Draftsperson has any questions concerning the formal drawings, he or she is respectfully requested to contact the undersigned. If any fees are due in connection with the filing of these drawings, then please charge such fees to our Deposit Account No. 50-0805 (Order No. LAM2P452).

Respectfully submitted,  
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